

**IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE**

In re Application of:) Group Art Unit: 2891
)
 Pei-Haw Tsao *et al.*) Examiner: Dana Farahani
)
 Serial No.: 10/711,503)
)
 Filed: September 22, 2004)
)
 For: **IC PACKAGE HAVING GROUND**)
 IC CHIP AND METHOD OF)
 MANUFACTURING SAME)
)

Submitted via EFS

Mail Stop: **AF**
Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

Dear Sir:

AMENDMENT IN RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. 1.116

This communication is in response to the Final Office Action of March 8, 2007. The Applicants note that the three month deadline for filing a response to this non-final Office Action is June 8, 2007; thus, this Response is timely. In addition, Applicant notes that the two-month deadline for filing a response to the Office Action is May 8, 2007; thus, this Response is being filed within the two-month shortened period for response under M.P.E.P. 706.07(f).